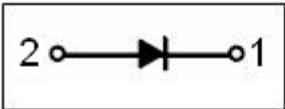


/ Descriptions

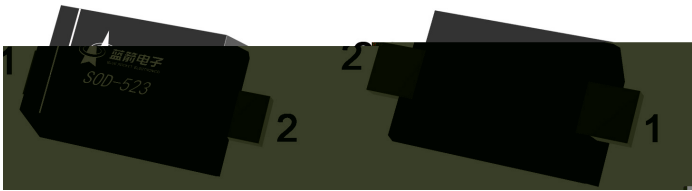
/ Features

/ Applications

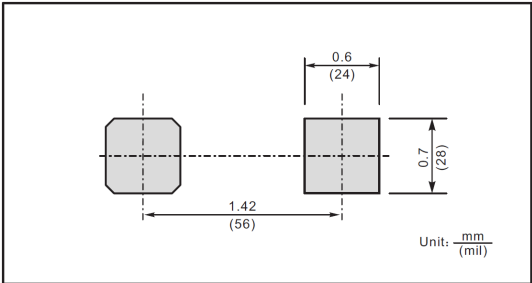
/ Equivalent Circuit



/ Pinning



The recommended mounting pad size



/ Marking

--	--

/ Absolute Maximum Ratings(Ta=25)

			℃
			℃

/ Electrical Characteristics(Ta=25)

		μ				
						μ
		Ω				

/ Electrical Characteristic Curve

Fig.1 Power Derating Curve

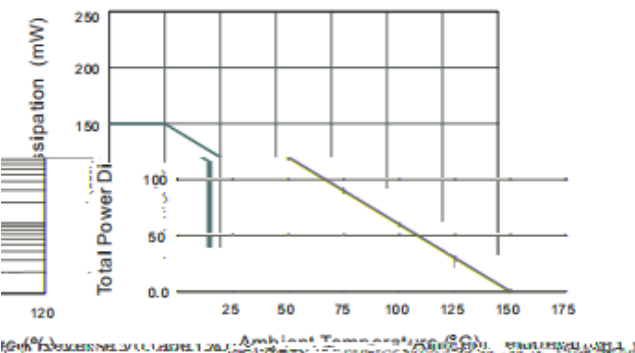
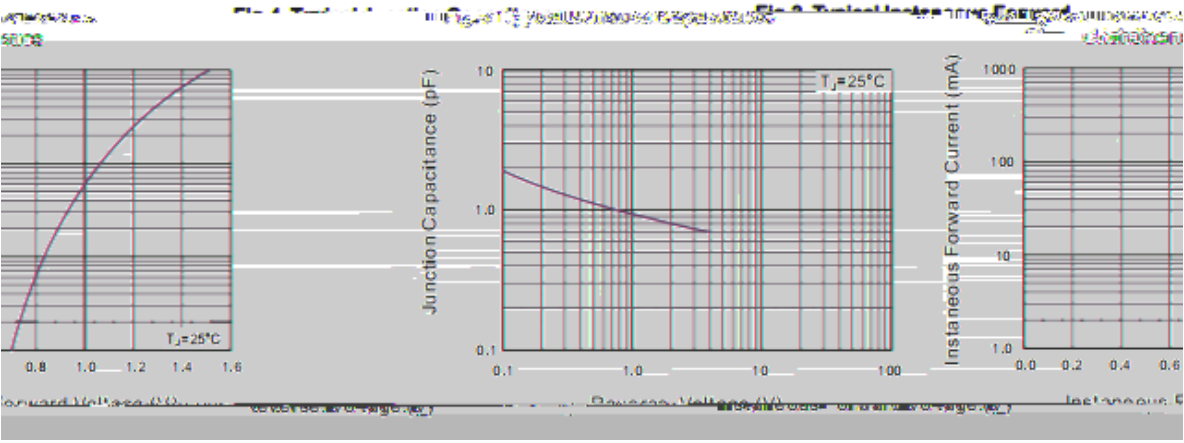
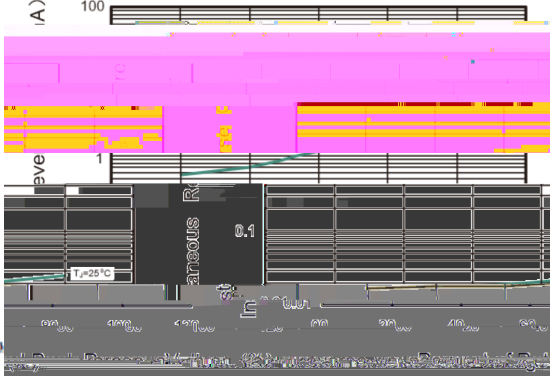
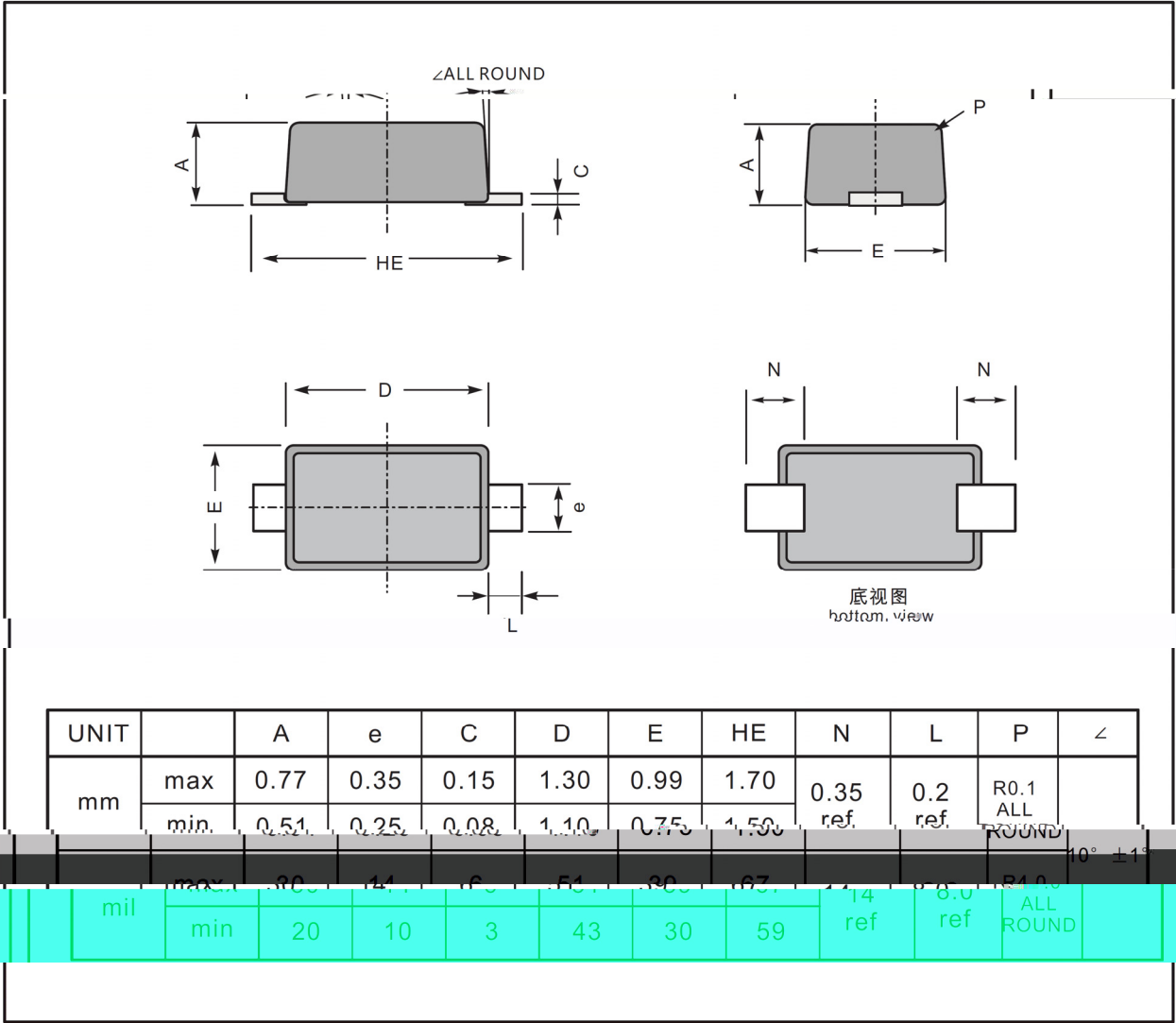


Fig.2 Typical Reverse Characteristics

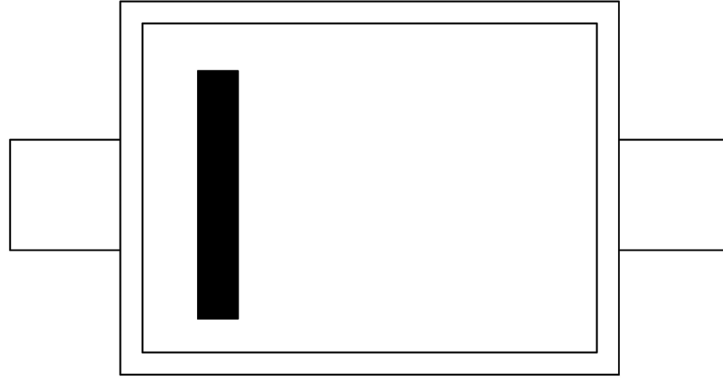


/ Package Dimensions

SOD-523

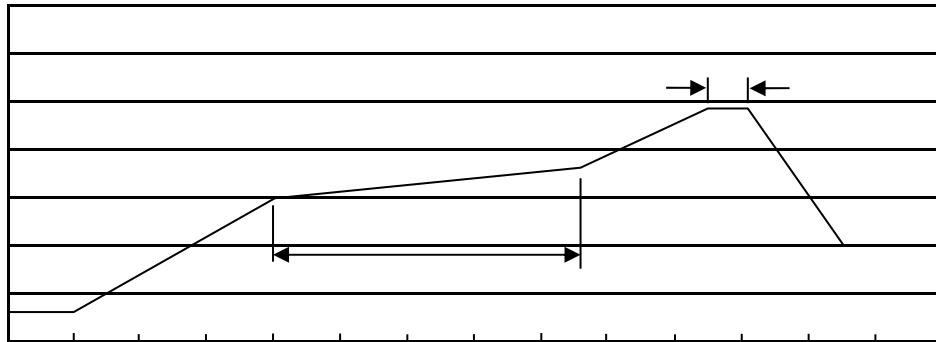


/ Marking Instructions



T4

() / Temperature Profile for IR Reflow Soldering(Pb-Free)

 $\pm$ $\pm$ $\pm$ $\pm$

/ Resistance to Soldering Heat Test Conditions

 $\pm$ $\pm$

°C

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box

/ Notices